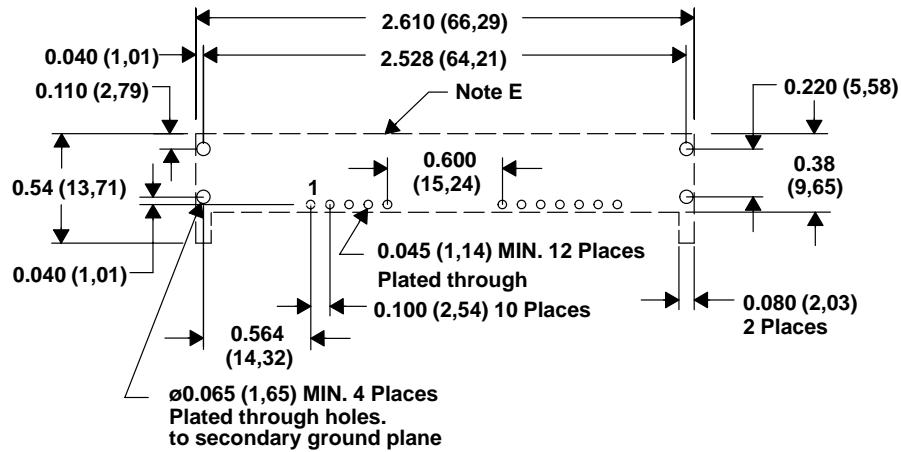
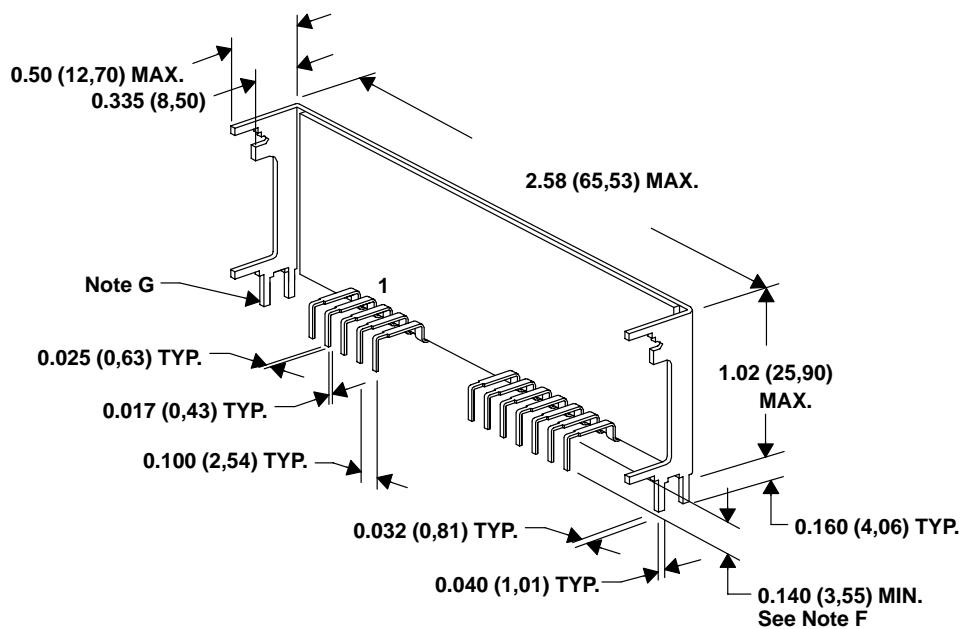


ELJ (R-MSIP-T12)

METAL SINGLE-IN-LINE MODULE

Suffix N



PC LAYOUT

4203514/B 12/01

NOTES:

- All linear dimensions are in inches (mm).
- This drawing is subject to change without notice.
- 2 place decimals are ± 0.030 (± 0.76 mm).
- 3 place decimals are ± 0.010 (± 0.25 mm).
- Recommended mechanical keep out area.
- Electrical pin length mounted on printed circuit board from seating plane to pin end.
- The case is electrically uncommitted. The recommended connection is to the secondary ground plane.

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265